

N-CHANNEL SILICON POWER MOS-FET

Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

Applications

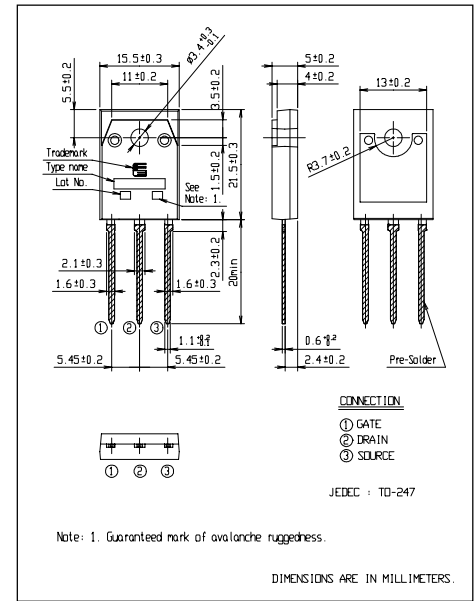
- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

Maximum ratings and characteristic Absolute maximum ratings

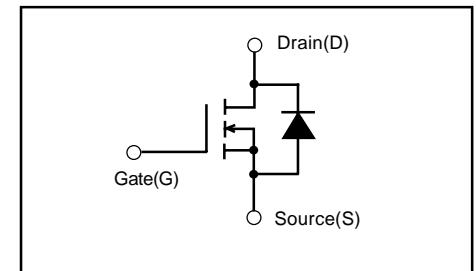
(T_c=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Drain-source voltage	V _{DS}	500	V
Continuous drain current	I _D	±27	A
Pulsed drain current	I _{D(puls)}	±108	A
Gate-source voltage	V _{GS}	±30	V
Repetitive or non-repetitive	IAR *2	27	A
Maximum Avalanche Energy	EAV *1	914	mJ
Max. power dissipation	P _D	400	W
Operating and storage temperature range	T _{ch} T _{stg}	+150 -55 to +150	°C

*1 L=2.30mH, V_{CC}=50V *2 T_{ch} ≤ 150°C



Equivalent circuit schematic



Electrical characteristics (T_c =25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D =1mA V _{GS} =0V	500			V	
Gate threshold voltage	V _{GS(th)}	I _D =1mA V _{DS} =V _{GS}	2.5	3.0	3.5	V	
Zero gate voltage drain current	I _{DSS}	V _{DS} =500V V _{GS} =0V	T _{ch} =25°C		10	500	μA
			T _{ch} =125°C		0.2	1.0	mA
Gate-source leakage current	I _{GSS}	V _{GS} =±30V V _{DS} =0V		10	100	nA	
Drain-source on-state resistance	R _{DS(on)}	I _D =13.5A V _{GS} =10V		0.16	0.2	Ω	
Forward transconductance	g _{fs}	I _D =13.5A V _{DS} =25V	11	22		S	
Input capacitance	C _{iss}	V _{DS} =25V		4300	6450	pF	
Output capacitance	C _{oss}	V _{GS} =0V		630	945	pF	
Reverse transfer capacitance	C _{rss}	f=1MHz		285	430	pF	
Turn-on time t _{on}	td(on)	V _{CC} =300V I _D =27A		40	60	ns	
	t _r	V _{GS} =10V		145	220		
Turn-off time t _{off}	td(off)	R _{GS} =10Ω		315	475	ns	
	t _f			150	225		
Total gate charge	Q _G	V _{CC} =250V		198	300	nC	
Gate-Source charge	Q _{GS}	I _D =27A		38	60		
Gate-Drain charge	Q _{GD}	V _{GS} =10V		81	125		
Avalanche capability	I _{AV}	L=2.30mH T _{ch} =25°C	27			A	
Diode forward on-voltage	V _{SD}	I _F =2xI _{DR} V _{GS} =0V T _{ch} =25°C		1.2	1.8	V	
Reverse recovery time	t _{rr}	I _F =I _{DR} V _{GS} =0V		660		ns	
Reverse recovery charge	Q _{rr}	-di/dt=100A/μs T _{ch} =25°C		15.0		μC	

Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	R _{th(ch-c)}	channel to case			0.3125	°C/W
	R _{th(ch-a)}	channel to ambient			50.0	°C/W

Characteristics

